

Annex B2 - Product environmental attributes Servers/Data Storage Products

The declaration may be published only when all rows and/or fields marked with * are filled-in (N/A for not applicable). Additional information regarding each item may be found under P15.

Brand *	Lenovo	Logo			
Company name *	Lenovo				
Contact information *	Lenovo Global Environmental Affairs	Lenovo			
e-mail address	Alvin L Carter	LEIIOVO			
	alcarter@lenovo.com				
Internet site *	https://www.lenovo.com/us/en/about/sustainability				
Additional information	The latest version of this document can be found at:				
	http://www.lenovo.com/ecodeclaration				

The company declares (The company declares (based on product specification or test results based obtained from sample testing), that the product				
conforms to the statement	nts given in this declaration.				
Type of product *	SERVER				
Commercial name *	ThinkSystem SR635 V3, ThinkAgile VXSR635 V3				
Model number *	7D9G, 7D9H, 7D9V				
Issue date *	2023-03-09				
Intended market *	🔀 Global 📃 Europe 🗌 Asia, Pacific & Japan 🗌 Americas 🗌 Other				
Additional information					

This is an uncontrolled copy when in printed form. Please refer to the contact information for the latest version.

About Annex B2

Annex B2 reflects Product environmental attributes relevant for Computers and Computer Monitors. The following items from the ECMA-370 Main body are not shown in the template:

P4.1 – P4.3 Consumable materials

P9.1 TEC and Print speed

P10.2 - P10.3 Chemical emissions from printing products

P11.1 - P11.3 Consumable materials for printing products.

wouern	umber *	7D9G, 7D9H, 7D9V Logo	Lon		
Issue date *		2023-03-09	Leng	JVC	
Produc	t environ	mental attributes - Legal requirements	Require	ment	met
ltem			Yes	No	N/A
P1		ous substances and preparations			
P1.1*	Products	do comply with current European RoHS Directive. (See legal reference and NOTE B1)	\boxtimes		
P1.2*		s do not contain Asbestos (see legal reference). nt: Legal reference has no maximum concentration value.	\boxtimes		
P1.3*	Products hydrobro trichloro	s do not contain Ozone Depleting Substances: Chlorofluorocarbons (CFC), mofluorocarbons (HBFC), hydrochlorofluorcarbons (HCFC), Halons, carbontetrachloride, 1,1,1- ethane, methyl bromide (see legal reference). Comment: Legal reference has no maximum ation values.			
P1.4*		do not contain more than; 0,005% polychlorinated biphenyl (PCB), 0,005% polychlorinated (I (PCT) in preparations (see legal reference).	\boxtimes		
P1.5*		do not contain more than 0,1% short chain chloroparaffins (SCCP) with 10-13 carbon atoms in the ntaining at least 48% per mass of chlorine in the SCCP (see legal reference).	e 🔀		
P1.6*	(see lega	rh direct and prolonged skin contact do not release nickel in concentrations above 0,5 μg/cm²/week al reference). nt: Max limit in legal reference when tested according to EN1811:2011-5.			
P1.7*	REACH	Article 33 information about substances in articles is available at (add URL or mail contact): www.lenovo.com/us/en/Lenovo-REACH-SVHC-			
P2	Batterie	S			
P2.1*		oduct contains a battery or an accumulator, the battery/accumulator is labeled with the disposal Information on proper disposal is provided in user manual. (See legal reference)	\boxtimes		
P2.2*	Batteries referenc	s or accumulators do not contain more than 0,0005% of mercury or 0,002% of cadmium. (See legal e)			
P2.3*	Batteries	and accumulators are readily removable. (See legal reference)	\square		
P2.4*	Docume	ntation includes the number of cycles the (secondary) battery can withstand. (See legal reference)			
P2.5*		ternal batteries of a notebook computer cannot be "accessed and replaced by a nonprofessional e related text is present and legible on the external packaging (see legal reference)			
P3		nity verification & Eco design (ErP)			
P3.1*	The proo	Juct is CE-marked to show conformance with applicable legal requirements (see legal reference). laration of Conformity can be requested at: https://www.lenovo.com/us/en/compliance/eu-doc https://www.lenovo.com/us/en/compliance/uk-doc for UK			
P3.2*		luct complies with the Eco design requirements for energy-related products, al reference).	\square		
	. 0	information is; information			
	declarat	lion			
P5		packaging			
P5.1*		ng and packaging components do not contain more than 0,01% lead, mercury, cadmium an ent chromium by weight of these together.	d 🔀		
P5.2*		kaging materials are marked with abbreviations and numbers indicating the nature of the material(s e legal reference).	s) 🔀		
P5.3*	The proc (see lega	luct packaging material is free from ozone depleting substances as specified in the Montreal Protoco al reference). nt: Legal reference has no maximum concentration values.	ol 🔀		
P6	Treatme	nt information			
-		on for recyclers/treatment facilities is available (see legal reference).	\boxtimes		

NOTE B1 Restriction applies to the homogeneous material, unless other specified and expressed in weight %. Stating "Yes" means that the product is compliant with the mandatory requirements.

Model nu	umber *	7D9G, 7D9H, 7D9V	Logo	Lon		
Issue da	te *	2023-03-09		Len		тн
Product	environ	mental attributes - Market requirements (See General NOTE GN	below)			
	- Enviro	onmental conscious design		Require	ment i	
Item		tory to fill in. Additional information regarding each item may be found under P14.		Yes	No	N/A
P7 P7.1*		Disassembly, recycling at have to be treated separately are easily separable				_
					<u> </u>	
P7.2*		naterials in covers/housing have no surface coating.			<u> </u>	
P7.3*		arts > 100 g consist of one material or of easily separable materials.				
P7.4*	•	arts > 25 g have material codes according to ISO 11469 referring ISO 1043-4.				
P7.5		arts are free from metal inlays or have inlays that can be removed with commonly a	available tools.	\square		
P7.6*		re easily separable. (This requirement does not apply to safety/regulatory labels).		\square		
		lifetime				
P7.7*		ng can be done e.g. with processor, memory, cards or drives		\square		
P7.8*	Upgradir	ng can be done using commonly available tools		\square		
P7.9	Spare pa	arts are available after end of production for: years				
P7.10	Service i	is available after end of production for: years				
		and substance requirements				
P7.11*		cover/housing material type (e.g. plastics, metal, aluminum):				
D7 40		type: <i>Metal</i> Material type: <i>Plastic</i> Materia	al type:			
P7.12		n materials of external electrical cables are PVC free.		<u> </u>		
P7.13		n materials of internal electrical cables are PVC free.				
P7.14	weight (plastic casing/cover parts > 25 g contain no more than 0,1% weight (1000 ppm) b 1000 ppm) chlorine attributable to brominated flame retardants, chlorinated flame	e retardants, a	and 🔤		
		l chloride or 0,3% weight (3000 ppm) bromine and 0,3% weight (3000 ppm) chlorine i an 25% post-consumer recycled content.	n parts contain	ing		
P7.15	Printed of	circuit boards, PCBs (without components) are low halogen: all \square PCBs > 25 g \square ed in IEC 61249-2-21. (See ⁵ NOTE B2)	are low halog	gen		
P7.16	Flame re Marking:	etarded plastic parts > 25 g in covers / housings are marked according ISO 1043-4:				
P7.17		hemical specifications of flame retardants in printed circuit boards > 25 g (without co	omponents):			
			, CAS #:			
		hemical specifications of flame retardants in printed circuit boards (without compone	,	_	_	
		g ISO 1043-4:	ents) > 25 g			
P7.18		ame retarded plastic parts > 25 g contain the following flame retardant substance	c/proparations			
F7.10		ations above 0,1%:	s/preparations			
		ical name: , CAS #: (See NOTE B4)				
		ical name: , CAS #: "				
	3. Chem	ical name: , CAS #: "				
	<u>Alt. 2: </u> Cl	hemical specifications of flame retardants in plastic parts > 25 g according ISO 104	3-4:			
P7.19	•	c parts > 25 g, flame retardant substances/preparations above $0,1\%$ are used which	n have been			
	•	d the following Risk phrases; and Hazard statements:				
			See note B5)			
P7.20*	Postcon	sumer recycled plastic material content is used in the product (See Note B6):			\bowtie	
	If YES: a	at least one of the two alternatives below shall be answered;				
	a) Of t	total plastic parts' weight > 25 g, the postconsumer recycled plastic material conten	t (calculated a	s		
		ercentage of total plastic by weight) is %.				
	or	success to the second sector of the second sector of the second sector of the second sector of the second sec				
1	b) The	e weight of recycled material is g.				

GENERAL NOTE Standard references should direct to the latest version of a standard. If an older version of a standard is used, section P15 shall be used for explanation.

NOTE B2 IEC 61249-2-21 defines maximum limits of 900 ppm for each of the substances chlorine and bromine and a maximum limit of 1500ppm of these substances combined. The standard does not address fluorine, iodine and astatine which are included in the group of halogens.

NOTE B3 and B4 A Guidance document on Chemical substances is available; see <u>http://www.ecma-international.org/publications/standards/Ecma-370.htm</u>.

NOTE B5 If a certain substance has been assigned a certain risk phrases / hazard statement in the referenced source, this does not necessarily mean the substance has been tested for all of the hazards referred to by a certain customer.

NOTE B6 Applies to a product containing plastic parts whose combined weight exceeds 100 g with the exception of printed circuit boards, cables, connectors and electronic components and bio-based plastic material.

Model number *	7D9G, 7D9H, 7D9V	Logo	Lenovo
Issue date *	2023-03-09		LEHOVO
Product environm	nental attributes - Market requirements (continued)	·	Requirement met

Item

	Material and subs	tance requirements (continued)				
P7.21*	Biobased plastic m	aterial content is used	in the product (See NC	DTE B7):			\boxtimes
	a) Of total plastic total plastic by or	parts' weight > 25 g, t	s below shall be answe the biobased plastic ma naterial is q.		ed as a percentage of		
P7.22*	Light sources are fr	ree from mercury, i.e. I	ess than 0,1 mg/lamp.			\square	
		specify: Number of larr		im mercury content per			
P7.23*	If product includes	an integral display, the	e total mercury content	in the integrated displa	y: mg		
P8	Batteries						
P8.1*	Battery chemical co	omposition: <i>Lithium M</i>	langanese Dioxide				
P9	Energy consumpt	ion (See NOTE B8)					
P9.1	For the product the	following power levels	s or energy consumptio	ns are reported:			
Energy mod	de *	Power level at 100 V AC	Power level at 115 V AC	Power level at 230 V AC	Reference/Standard modes and test metho		energy
Peak (On-r	max)	W	W	W	Full load		
Category	/						
EPS No-load (External power supply / charger plugged in the wall outlet but disconnected from		W	W	W			
the product							
PTEC *	-7	W	W	W			
Typical Ene	ergy Consumption						
ETEC * Annual Energy Consumption		kWh/year	kWh/year	kWh/year			
External Po	wer Supply Efficiend	cy Level (International	Efficiency Marking Pro	tocol) *:			
Display res	olution * : me	egapixels					
Default time	e to enter energy sav	ve mode: minut	es				
P9.2*	Information about t	he energy save function	on is provided with the p	product.	•	\boxtimes	

P9.3	Energy efficiency class (monitors only):				
P10	Emissions Noise emiss	ion – Declared according to ISO 9296 (See NO	TE B9)		
P10.1	Mode	Mode description	Statistical upper limit A-weighted sound power level, L _{WA,c} (B)		
	Idle	* Typical Configuration	*6.7		
	Operation	* Typical Configuration (Stress CPU to 80% TDP or Stress GPU to TDP)	*8.4		
	Idle	* GPU Rich Configuration	* 6.7		
	Operation	* GPU Rich Configuration (Stress CPU to 80% TDP or Stress GPU to TDP)	* 8.3		
	Idle	* Storage Rich Configuration	*7.4		
	Operation	* Storage Rich Configuration (Stress CPU to 80% TDP or Stress GPU to TDP)	*7.9		
	Measured according to: ISO 7779 ECMA-74 Other (only if not covered by ECMA-74)				
	Electromagr	etic emissions			
P10.4	Computer dis program(s):	play meets the requirement for low frequency el	lectromagnetic fields of the following voluntary		

NOTE B8 A Guidance document on Energy Efficiency is available; see http://www.ecma-international.org/publications/standards/Ecma-370.htm Yes

No

N/A

 \boxtimes

 \boxtimes

 \boxtimes

 \boxtimes

 \boxtimes

 \boxtimes

NOTE B7 The following is to be excluded from the calculation of percentage: printed circuit boards, labels, cables, connectors and electronic components and postconsumer recycled plastic

NOTE B9 A Guidance document on Acoustic Noise is available; see http://www.ecma-international.org/publications/standards/Ecma-370.htm

Model nu	ımber *	7D9G, 7D9H, 7D9	/				Logo	Lama		
Issue dat	te *	2023-03-09						Leno	VO	-
Product	environr	nental attributes	- Market requir	rements (conti	inued)			Require	ment	met
Item				•				Yes	No	N/A
P12		mics for computing								
P12.1*	The disp	lay meets the ergon	omic requirement	ts of ISO 9241-30)7 for visual o	lisplay technolo	gies.			\boxtimes
P12.2*	The phy	sical input device me	ets the requireme	ents of ISO 9995	and ISO 924	1-410.				\boxtimes
P13		ing and documenta								
P13.1*	Product Product	packaging material t packaging material t packaging material t packaging material t	ype(s): Paper - C ype(s): Plastic - ;	Corrugated singl Solid EPE (solid	l <mark>e wall</mark> weig I Expanded	ht (kg): 0.228		8		
P13.2*	Product	plastic primary pack	aging is free from	ı PVC.				\boxtimes		
P13.3*		duct primary corrugater recovered fiber co		oackaging, specif	y the contair	ned percentage	of minimum po	ost-		
P13.4*		media for user and p ronic, 🔀 Paper, 🔲	roduct documenta Other	tation (tick box):						
P13.5	Ùser and	only complete this it d product documenta lease specify:			ee:					
	,	hlorine-free al chlorine-free								
	Process	ed chlorine-free						Π		
P14	Volunta	ry programs								
P14.1	The proc	duct meets the requi	rements of the fol	llowing voluntary	program(s):					
	Eco-labe	el: ENERGY STAR	Eco-label:	I	Eco-label:	Eco-labe	el:			
	Eco-labe	el:	Eco-label:	1	Eco-label:	Eco-labe				
P15		nal information (Se	NOTE B10)							
P 9		consumption of co		s; description of	f the tested p	product config	uration:			
	the info supplie informa Accoun	Supplier makes no rmation contained r's knowledge avail tion. The information t Representative fo	in this document able at the time on provided here r more informati	nt. All information of completion, a e is approximate tion.	n provided k and supplier and provid	by supplier in t shall have no ed for informat	his document is obligation to up	s provided pdate such	based	lon
P 9		ergy Star Qualified www.energystar.go								

NOTE B10 Additional lines may be inserted to declare further items, by positioning the cursor at the far right of the row and hitting the <Enter> key.

Legal references Europe Annex B2

Reference	Declaration item
Directive 2011/65/EU (RoHS Directive)* * Specific exemptions apply for certain products and applications.	P1.1, P3.1
Regulation (EC) 1907/2006 (REACH Regulation), annex XVII	P1.2, P1.4, P1.6, P1.7
Regulation (EC) 2037/2000, 2038/2000, 2039/2000 (Marketing and use of Ozone layer depleting substances)	P1.3, P5.3
Norwegian regulation relating to restrictions on the use of certain dangerous chemicals 20.12.2002	P1.5
Directive 2006/66/EC (Battery and accumulators Directive), as amended.* * These provisions shall not apply where, for safety, performance, medical or data integrity reasons, continuity of power supply is necessary and requires a permanent connection between the appliance and the battery or accumulator.	P2.1, P2.2, P2,3, P8.1
Directive 2014/35/EU (Low Voltage Directive)	P3.1
Directive 2014/30/EU (EMC Directive)	P3.1
Directive 2014/53/EU (RE Directive)	P3.1
Regulation (EC) 801/2013 amending Regulation (EC) No 1275/2008 with regard to ecodesign requirements for standby, off mode electric power consumption of electrical and electronic household and office equipment, and amending Regulation (EC) No 642/2009 with regard to ecodesign requirements for televisions	P3.1, P3.2
Commission Regulation (EC) No 278/2009 of 6 April 2009 implementing Directive 2005/32/EC of the European Parliament and of the Council with regard to ecodesign requirements for no-load condition electric power demand and average active efficiency of external power supplies	P3.1, P3.2, P9.1
COMMISSION REGULATION (EU) No 617/2013 of 26 June 2013 implementing Directive 2009/125/EC of the European Parliament and of the Council with regard to ecodesign requirements for computers and computer servers	P2.4, P2.5, P3.1, P3.2, P7.23, P9.1
Regulation (EC) No 1272/2008 (CLP Regulation)	P7.19
Directive 2004/12/EC (Packaging Directive)	P5.1
Decision 97/129/EC (Secondary packaging legislation)	P5.2
Directive 2012/19/EU (WEEE directive)	P6.1
Implementing Regulation (EU) 2019/290 establishing the format for registration and reporting of producers of electrical and electronic equipment to the register.	
Commission Implementing Regulation 2017/699 establishing a common methodology for the calculation of the weight of electrical and electronic equipment (EEE) placed on the national market in each Member State and a common methodology for the calculation of the quantity of waste electrical and electronic equipment (WEEE) generated by weight in each Member State.	

Lenovo ErP Lot9 Information Sheet - Servers & Storage Products-

As required by COMMISSION REGULATION (EU) 2019/424 of 15 March 2019 laying down ecodesign requirements for servers and data storage products pursuant to Directive 2009/125/EC of the European Parliament and of the Council and amending Commission Regulation (EU) No 617/2013. (ErP Lot9)

Products scope of this sheet: Servers & storage products

This document is only valid in connection with the IT Eco Declaration of the specific Product.

SERVERS

General information				
Commercial name (3.1 (b))	ThinkSystem SR635 V3	Logo		
Contact Address (3.1 (b))	7001 Development Dr. Building 7 Morrisville, NC 27560 United States	Lenovo		
Model Number (3.1 (c))	7D9G, 7D9H			
Issue Date	2023-03-09	1		
Additional information				

Product	environmental attributes (EU) 2019/424 – Annex II points 3.1 and 3.3
1.a	Is the product consider to be in scope of ErP Lot 9 🛛 in scope 🗌 out of scope, product is out of scope as:
1.b (3.1 (a))	Server type Rack Server High Performance Computing (HPC) Tower Server Multi Node Server Blade Server Data Storage product (Please go to "DATA STORAGE PRODUCTS" section
1.c (3.1 (d))	Year of manufacture: 2023
1.d (3.1 (p))	Product model part of a server product family? No X Yes List of all model configurations that are represented by the model: https://lenovopress.lenovo.com/servers/thinksystem-v3/sr635- v3#sort=relevance
1.e (3.1 (n))	Information on the secure data deletion functionality
	 (a) instructions on how to use the functionality: 2 methods are provided to use the functionality. 1) Use a command line tool to do the secure data deletion on the remote target system via boot up a customized Linux OS on it. Eg: OneCli.exe serase -bmc USERID:PASSWORD@xx.xx.xxsftp root:password@xx.xxx.xx./home - log 5 2) Use BoMC to create a full functions bootable media, start the media and choose secure erase from the text menu. (b) techniques used: OS tools under Linux -> Standard Linux Open Source tool (c) supported secure data deletion standard (if any): Secure Erase/block Erase/Crypto Erase, Sanitze
	OR - Reference to other information: Hdparm: <u>https://en.wikipedia.org/wiki/Hdparm</u>
	Nvme-format: https://www.mankier.com/1/nvme-format
	sg_sanitize: <u>https://www.systutorials.com/docs/linux/man/8-sg_sanitize/</u>
	scrub: https://www.systutorials.com/docs/linux/man/1-scrub/
	storcli: <u>https://docs.broadcom.com/docs-and-downloads/raid-controllers/raid-controllers-common-</u> <u>iles/StorCLI_RefMan_revf.pdf</u>
1.f (3.1 (o))	Blade servers? 🛛 🖸 No 🔲 Yes list of recommended combinations with compatible chassis:
Recyclin	ng Data
2.a (3.3 (a))	Indicative weight range at component level, of the following critical raw materials: (a) Cobalt in the batteries (b) Neodymium in the HDDs Indicative weight range at component level, of the following critical raw materials: (a) Cobalt in the batteries (b) Neodymium in the HDDs Indicative weight range at component level, of the following critical raw materials: (a) Cobalt in the batteries (b) Neodymium in the HDDs Indicative weight range at component level, of the following critical raw materials: (a) Cobalt in the batteries (b) Neodymium in the HDDs Indicative weight range at component level, of the following critical raw materials: (a) Cobalt in the batteries (b) Neodymium in the HDDs Indicative weight range at component level, of the following critical raw materials: (a) Cobalt in the batteries (b) Neodymium in the HDDs Indicative weight range at component level, of the following critical raw materials: (b) Neodymium in the HDDs (c) Neodymium in the HDDs Indicative weight range at component level, of the following critical raw materials: (c) Neodymium in the HDDs (c) Neodymium in the HDDs Indicative weight range at component level, of the following critical raw materials: (c) Neodymium in the HDDs (c) Neodymium in the HDDs Indicative weight range at component level, of the following critical raw materials: (c) Neodymium in the HDDs (c) Neodymium in the HDDs

2.b (3.3 (b))	Instructions on the disassembly operations (a) the type of operation; (b) the type and number of fastening technique(s) to be unlocked; (c) the tool(s) required.
	OR - Reference to other information: https://pubs.lenovo.com/sr635-v3/sr635_v3_hardware_maintenance_guide.pdf
2.c	Firmware Reference to information on last available firmware: https://datacentersupport.lenovo.com/us/en/products/servers/thinksystem/sr635v3/downloads/driver-list/
Addition	al information

Server family specific information Family 1

	no. / name	🛛 🖄 1 - 1 CPU populated fam			
Model number(s) / Description (3.1 (c))		Standard or low-end performance configuration: Processor(Minimum result of core count * frequency in family): AMD EPYC processor 9124 * 1,			
		High-end performance confi			
		Processor(Maximum result	of core count ^ frequency in fa	mily):	AMD EPYC processor 9654 * 1,
		You can refer to	mory: 64GB * 12, PSU: 1800W	/ [*] Z	
			ons.com/80PlusPowerSupplies	Dotail	asnx2id=40&type=1
		along with	ins.com/our lusi owerouppiles	Detail	<u></u>
Addition	nal information		com/servers/thinksystem-v3/si	r635-v	3&
		https://dcsc.lenovo.com/#/c	ategories/STG%40Servers%40	Rack%	%20and%20Tower%20Servers%407
		hinkSystem%20SR635%20V	/3		
		butes (EU) 2019/424 – Annex			
1.a			nd 100 % of rated output power		
3.1 (e))	(expressed in % and	rounded to the first decimal pla	ice): 🗌 Multi-output 🛛 🛛 Single	e-outpi	ut
	Standard or low-end performance configuration(s): 10% 93.16 20% 95.23 50% 96.07 100% 94.79 Average 95.36				
	10% 93.70 20% 93	5.23 50% 96.07 100% 94.79	Average 95.36		
	High-end performance				
	10% 92.38 20% 94	1.75 50% 96.19 100% 95.15	Average 93.27		
-1.b	Power factor at 50 %	of the rated load level	standard or low-end performa	nce	high-end performance
3.1 (f))	(rounded to three de	cimal places)	configuration: 0.990		configuration: 1
1.c	PSU rated power out	tput	standard or low-end performa	nce	high-end performance
3.1 (g))	(in Watts rounded to	the nearest integer)	configuration: 750		configuration: 1800
	internal note:				
	If a product model is part of a ser product family shall be reported y	ver product family, all PSUs offered in a server vith the information specified in (e) and (f)			
-1.d	idle state power		standard or low-end performa	nce	high-end performance
3.1 (h))	(in Watts and rounde	ed to the first decimal place)	configuration: 90.2		configuration: 105.6
F1.e	List of all component	ts for additional idle power allow	vances		
3.1 (i))				la l'aula	
3.1 (i))			or low-end performance		end performance
3.1 (i))	CPUPerformance	configurati	or low-end performance on:	confi	guration:
3.1 (i))	CPU Performance	configurati	or low-end performance ion: ket (10 × PerfCPU W)	config 1	guration: I Socket
		configurati	or low-end performance on:		guration: I Socket 2 Socket
	Additional PSU	configurati ∑ 1 Soci ∑ 2 Soci No #: 1	or low-end performance ion: ket (10 × PerfCPU W)	config 1 2 Yes	guration: Socket 2 Socket #: 1
	Additional PSU HDD	configurati 1 Soci 2 Soci No #: 1 Yes #: 2	or low-end performance ion: ket (10 × PerfCPU W)	config 1 2 Yes No #	guration: Socket 2 Socket #: 1 :: 0
ijustments	Additional PSU HDD SDD	configurati I Sock 2 Sock No #: 1 Yes #: 2 No #: 0	or low-end performance ion: ket (10 × PerfCPU W) ket (7 × PerfCPU W)	confi 1 2 Yes No # Yes	guration: I Socket 2 Socket #: 1 :: 0 #: 2
ijustments	Additional PSU HDD SDD Additional memory	configurati I Soci 2 Soci No #: 1 Yes #: 2 No #: 0 Yes #: 192	or low-end performance ion: ket (10 × PerfCPU W) ket (7 × PerfCPU W)	Config 1 2 Yes No # Yes	guration: Socket Socket #: 1 : 0 #: 2 #: 768GB
ijustments	Additional PSU HDD SDD Additional memory Additional buffered DDF	configurati 1 Soci 2 Soci No #: 1 Yes #: 2 No #: 0 Yes #: 192 R channel	or low-end performance ion: ket (10 × PerfCPU W) ket (7 × PerfCPU W)	confi 1 2 Yes No # Yes No #	guration: Socket Socket #: 1 :: 0 #: 2 #: 768GB :: 0
ijustments	Additional PSU HDD SDD Additional memory	configurati 1 Soci 2 Soci No #: 1 Yes #: 2 No #: 0 Yes #: 0 R channel No #: 0	or low-end performance ion: ket (10 × PerfCPU W) ket (7 × PerfCPU W)	confii 1 2 Yes No # Yes No #	guration: I Socket 2 Socket #: 1 :: 0 #: 2 #: 768GB :: 0 one
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e power allowances adjustments during testing	Additional PSU HDD SDD Additional memory Additional buffered DDF	configurati □ 1 Sock □ 2 Sock No #: 1 Yes #: 2 No #: 0 Yes #: 19: R channel No #: 0 □ none <1 Gb/s	vr low-end performance ion: ket (10 × PerfCPU W) ket (7 × PerfCPU W) 2GB 2GB 2 No Allowance : 2,0 W/Active Port and < 10 Gb/s: 4,0 W/Active Port s and < 25Gb/s: 15,0 W/Active Port	confil I	guration: I Socket 2 Socket #: 1 : 0 #: 2 #: 768GB : 0 one 1 Gb/s: No Allowance 1 Gb/s: 2,0 W/Active Port 1 Gb/s and < 10 Gb/s: 4,0 W/Active Port 10 Gb/s and < 25Gb/s: 15,0 W/Active Port
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